

80V N-Ch Power MOSFET

Feature

- High Speed Power Switching
- Enhanced Body diode dv/dt capability
- Enhanced Avalanche Ruggedness
- 100% UIS Tested, 100% Rg Tested
- Lead Free

Application

- Synchronous Rectification in SMPS
- Hard Switching and High Speed Circuit
- Power Tools
- UPS
- Motor Control

$V_{DS}$		80	V
$R_{DS(on),typ}$	TO-263	1.75	mΩ
$R_{DS(on),typ}$	TO-247	1.92	mΩ
$R_{DS(on),typ}$	TO-220	2.00	mΩ
$I_D$ (Silicon Limited)		290	A
$I_D$ (Package Limited)		205	A

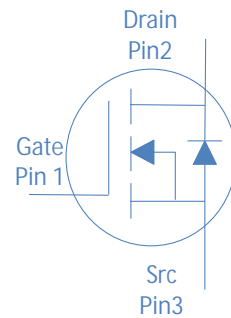
TO-263



TO-220



TO-247



Part Number	Package	Marking
HGB021N08S	TO-263	GB021N08S
HGK023N08S	TO-247	GK023N08S
HGP024N08S	TO-220	GP024N08S

Absolute Maximum Ratings at  $T_j=25$  (unless otherwise specified)

Parameter	Symbol	Conditions	Value	Unit
Continuous Drain Current (Silicon Limited)	$I_D$	$T_C=25$	290	A
		$T_C=100$	205	
		$T_C=25$	120	
Continuous Drain Current (Package Limited)		$T_C=25$	120	
Drain to Source Voltage	$V_{DS}$	-	80	V
Gate to Source Voltage	$V_{GS}$	-	±20	V
Pulsed Drain Current	$I_{DM}$	-	900	A
Avalanche Energy, Single Pulse	$E_{AS}$	$L=0.4mH, T_C=25$	720	mJ
Power Dissipation	$P_D$	$T_C=25$	375	W
Operating and Storage Temperature	$T_J, T_{stg}$	-	-55 to 175	

Absolute Maximum Ratings

Parameter	Symbol	Max	Unit
Thermal Resistance Junction-Case	$R_{JC}$	0.4	°W
Thermal Resistance Junction-Ambient	$R_{JA}$	60	°W

**Electrical Characteristics at  $T_j=25$  (unless otherwise specified)**
**Static Characteristics**

Parameter	Symbol	Conditions	Value			Unit	
			min	typ	max		
Drain to Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=250\mu A$	80	-	-	V	
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS}=V_{DS}, I_D=250\mu A$	2	3	4		
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{GS}=0V, V_{DS}=80V, T_j=25$	-	-	1	$\mu A$	
		$V_{GS}=0V, V_{DS}=80V, T_j=100$	-	-	100		
Gate to Source Leakage Current	$I_{GSS}$	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	$\pm 100$	nA	
Drain to Source on Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=20A$	TO-263	-	1.75	2.1	m $\Omega$
			TO-247	-	1.92	2.3	
			TO-220	-	2.00	2.4	
Transconductance	$g_{fs}$	$V_{DS}=5V, I_D=20A$	-	80	-	S	
Gate Resistance	$R_G$	$V_{GS}=0V, V_{DS}$ Open, $f=1MHz$	-	0.7	-	$\Omega$	

**Dynamic Characteristics**

Input Capacitance	$C_{iss}$	$V_{GS}=0V, V_{DS}=40V, f=1MHz$	-	10700	-	pF
Output Capacitance	$C_{oss}$		-	1260	-	
Reverse Transfer Capacitance	$C_{rss}$		-	38	-	
Total Gate Charge	$Q_g$	$V_{DD}=40V, I_D=20A, V_{GS}=10V$	-	124	-	nC
Gate to Source Charge	$Q_{gs}$		-	37	-	
Gate to Drain (Miller) Charge	$Q_{gd}$		-	10	-	
Turn on Delay Time	$t_{d(on)}$	$V_{DD}=40V, I_D=20A, V_{GS}=10V, R_G=3\Omega,$	-	35	-	ns
Rise time	$t_r$		-	23	-	
Turn off Delay Time	$t_{d(off)}$		-	70	-	
Fall Time	$t_f$		-	13	-	

**Reverse Diode Characteristics**

Diode Forward Voltage	$V_{SD}$	$V_{GS}=0V, I_F=20A$	-	0.9	1.2	V
Reverse Recovery Time	$t_{rr}$	$V_R=40V, I_F=20A, di_F/dt=400A/\mu s$	-	77	-	ns
Reverse Recovery Charge	$Q_{rr}$		-	420	-	nC

Fig 1. Typical Output Characteristics

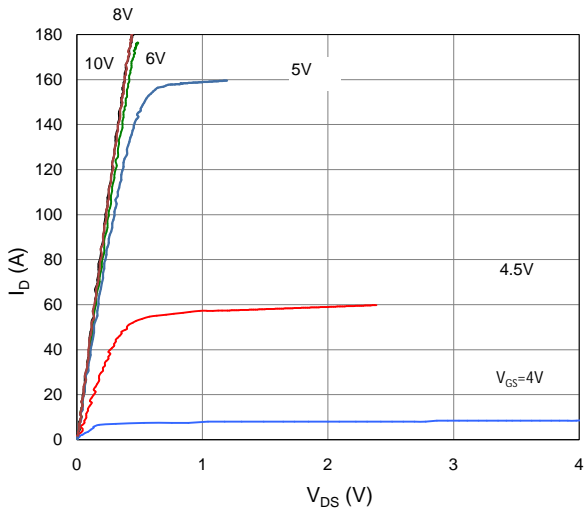


Figure 2. On-Resistance vs. Gate-Source Voltage

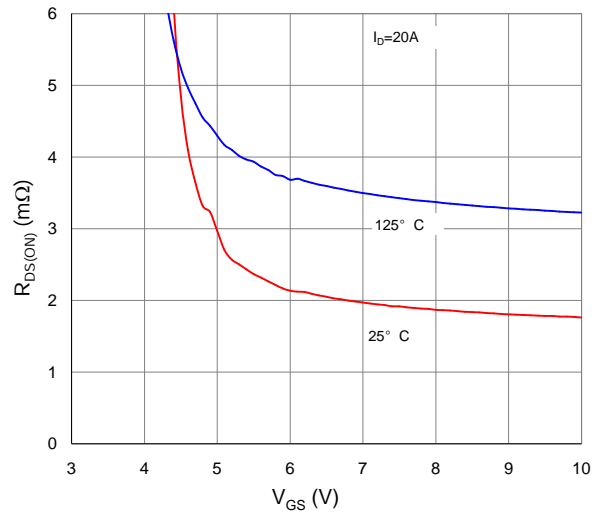


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

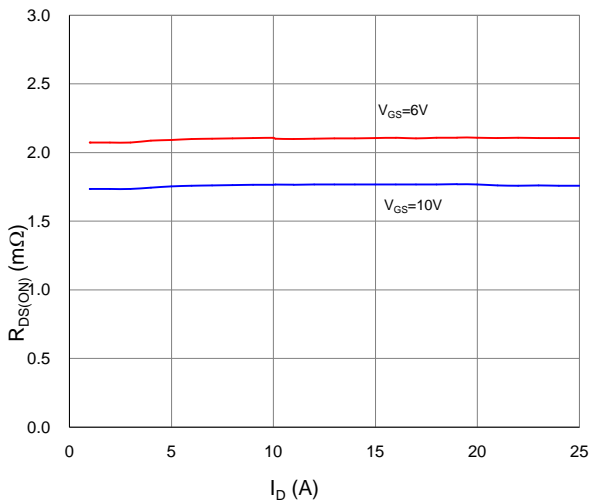


Figure 4. Normalized On-Resistance vs. Junction Temperature

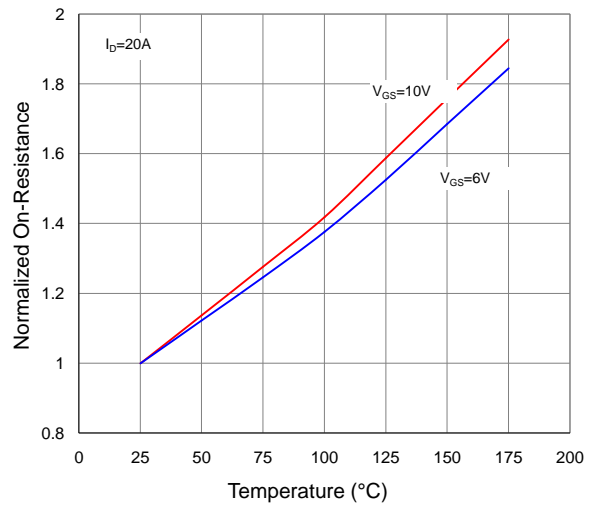


Figure 5. Typical Transfer Characteristics

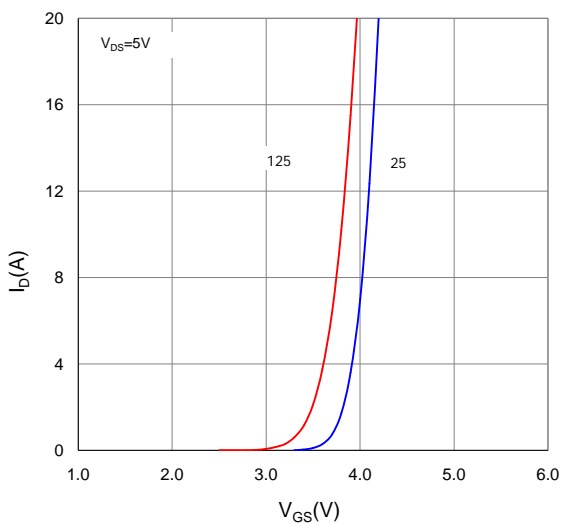


Figure 6. Typical Source-Drain Diode Forward Voltage

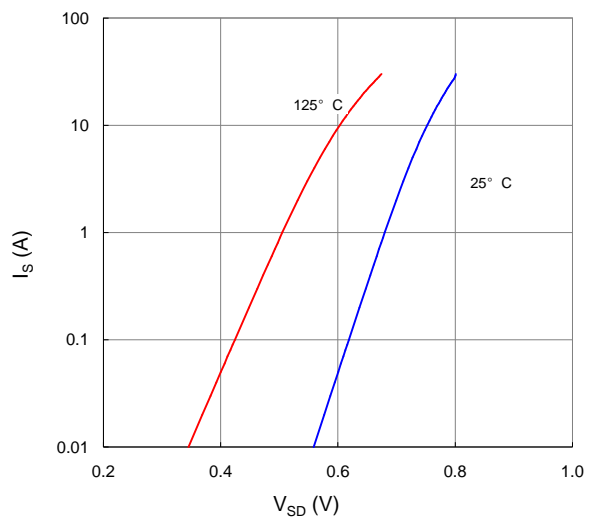


Figure 7. Typical Gate-Charge vs. Gate-to-Source Voltage

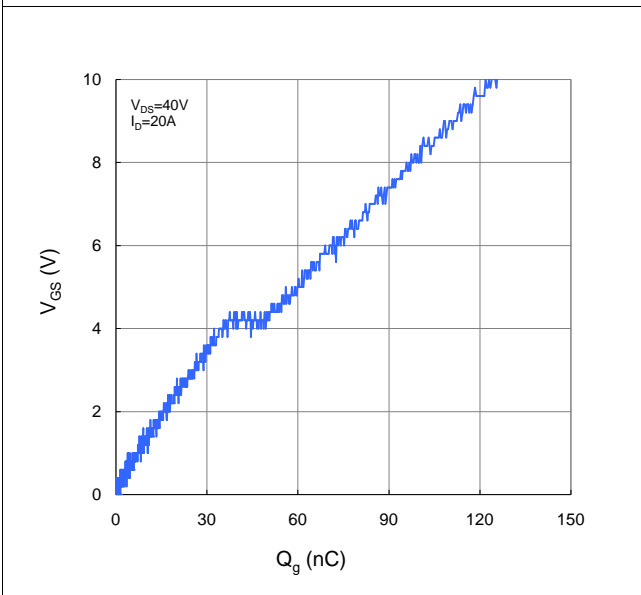


Figure 8. Typical Capacitance vs. Drain-to-Source Voltage

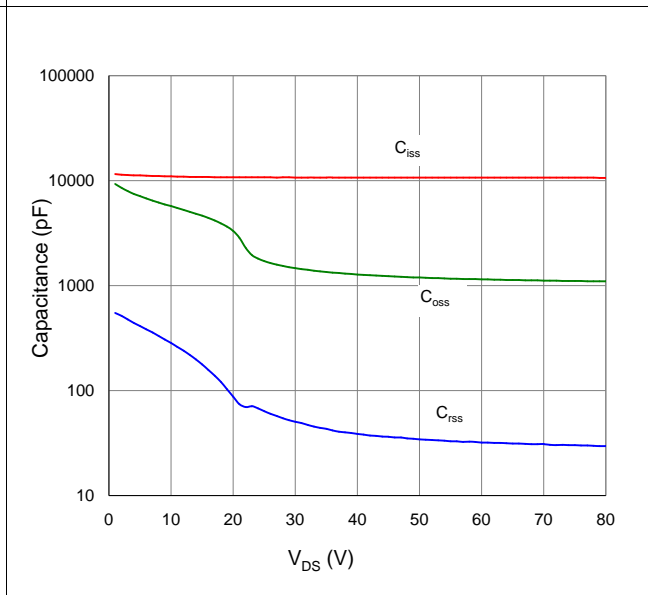


Figure 9. Maximum Safe Operating Area

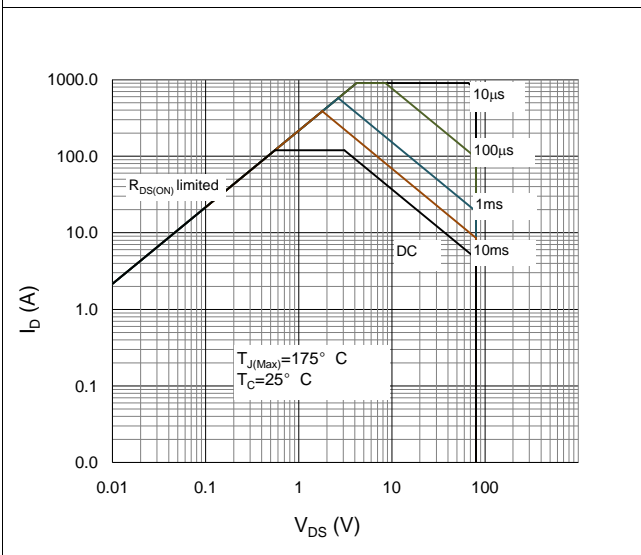


Figure 10. Maximum Drain Current vs. Case Temperature

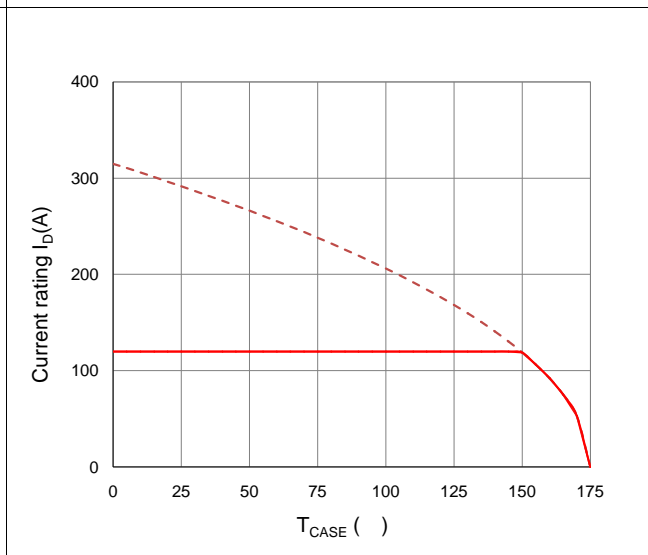
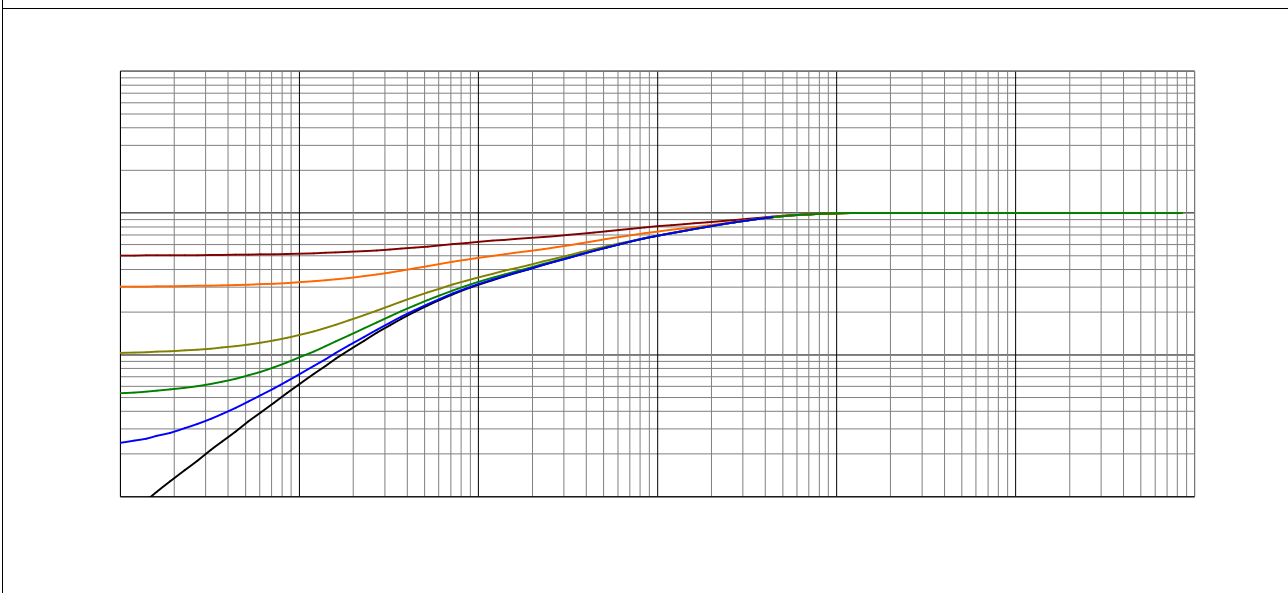
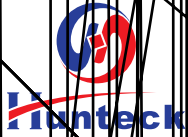


Figure 11. Normalized Maximum Transient Thermal Impedance, Junction-to-Case

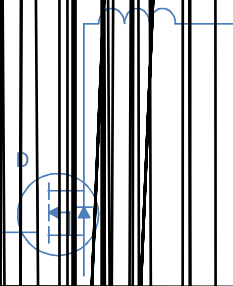




Inductive switching Test

Gate Charge Test

Uclamped Inductive Switching (UIS) Test



Diode Recovery Test

A	9.66	9.97	10.28
A2	9.80	10.00	10.20
B	15.60	15.70	15.80
C	12.70	13.48	14.27
D	4.30	4.50	4.70

2802099 1.200 1802099 20.9 23099 24.8 170015.98 62..52966223

1.52

G3	0.45	0.52	0.60
H			
I	2.70	2.80	2.90
J	15.70	15.97	16.25
K	2.20	2.40	2.60
L	1.15	1.27	1.40
N	6.40	6.60	6.80

**TO-263, 2 leads**

Dimintions in mm unless otherwise specified

Symbol	Min	Nom	Max
A	9.66	9.97	10.28
B	1.02	1.17	1.32
C	8.59	9.00	9.40
D1	1.14	1.27	1.40
D2	0.70	0.83	0.95
D3		5.08	
E	15.09	15.24	15.39
F	1.15	1.28	1.40
G	4.30	4.50	4.70
H	2.29	2.54	2.79
I		0.25	
K	1.30	1.45	1.60
a1	0.45	0.55	0.65
a2(degree)	0°		8°

